

H310MHC2 Motherboard



- Supports 9th & 8th Generation Intel® Core $^{\text{\tiny TM}}$ Processor
- Intel H310 single chip architecture
- Support 2-DIMM DDR4-1866/ 2133/ 2400/ 2666 up to 32G maximum capacity
- Support USB 3.1 Gen1
- Support HDMI display port
- Support GbE LAN

Specifcation	
CPU SUPPORT	9th Gen Intel® Core™ i9 LGA 1151 Processor 9th Gen Intel® Core™ i7 LGA 1151 Processor 9th Gen Intel® Core™ i5 LGA 1151 Processor 9th Gen Intel® Core™ i3 LGA 1151 Processor 8th Gen Intel® Core™ i7 LGA 1151 Processor 8th Gen Intel® Core™ i5 LGA 1151 Processor 8th Gen Intel® Core™ i3 LGA 1151 Processor 8th Gen Intel® Core™ i3 LGA 1151 Processor 8th Gen Intel® Pentium® LGA 1151 Processor 8th Gen Intel® Celeron® LGA 1151 Processor Maximum CPU TDP (Thermal Design Power) : 95Watt
MEMORY	Support Dual Channel DDR4 1866/2133/2400/2666 MHz 2 x DDR4 DIMM Memory Slot Max. Supports up to 32GB Memory Each DIMM supports non-ECC 4/8/16GB DDR4 module
INTEGRATED VIDEO	By CPU model Supports DX12 Supports HDCP
STORAGE	4 x SATA III Connectors
LAN	Realtek RTL8111H - 10/100/1000Mb/s Controller
AUDIO CODEC	Realtek ALC887 8-Channel HD Audio
USB	4 x USB 3.1 Gen1 Ports (2 on rear I/Os and 2 via internal header) 6 x USB 2.0 Ports (2 on rear I/Os and 4 via internal header)
EXPANSION SLOT	1 x PCI-E 3.0 x16 Slot 2 x PCI-E 2.0 x1 Slots

REAR I/O	1 x PS/2 Mouse 1 x PS/2 Keyboard 2 x USB 3.1 Gen1 Ports 2 x USB 2.0 Port 1 x HDMI Connector, resolution up to 4096 x 2160 @24Hz 1 x VGA Port ,resolution up to 1920 x 1200 @60Hz 1 x LAN Port 3 x Audio Jacks
INTERNAL I/O	1 x USB 3.1 Gen1 Header (each header support 2 USB 3.1 Gen1 ports) 2 x USB 2.0 Headers (each header support 2 USB 2.0 ports) 4 x SATA III Connectors (6Gb/s) 1 x Front Audio Header 1 x Front Panel Header 1 x CPU Fan Connector 1 x System Fan Connector 1 x 4-Pin Power Connector 1 x 24-Pin Power Connector 1 x Clear CMOS Header 1 x COM Port Header
H/W MONITORING	CPU / System Temperature Monitoring CPU / System Fan Monitoring Smart / Manual CPU / System Fan Control System Voltage Monitoring
DIMENSION	Micro ATX Form Factor Dimension: 22.6 cm x 17.1 cm (W x L)
OS SUPPORT	Supports Windows 10(x64) / 11(64bit) Windows 7 *Biostar reserves the right to add or remove support for any OS with or without notice.
BUNDLE SOFTWARE	BullGuard
ACCESSORIES	2 x SATA Cable 1 x I/O Shield 1 x DVD Driver 1 x Quick Guide

OVERVIEW



Intel H310 chipset

The Intel® H310 chipset is a single-chipset design to support socket 1151 Intel® 8th generation Intel® Core™ processor-based platform. Provides excellent performance and increased bandwidth and stability. The PC platform features improved adaptive performance that adds speed when you need it. When combined with advanced system responsiveness, the platform delivers the ultimate PC experience.



HD Audio

Provides high quality sound with minimal loss of audio fidelity.



DX12

DirectX 12 introduces the next version of Direct3D, the graphics API at the heart of DirectX. Direct3D is one of the most critical pieces of a game or game engine, and we've redesigned it to be faster and more efficient than ever before. Direct3D 12 enables richer scenes, more objects, and full utilization of modern GPU hardware.



Integrated HDMI with HDCP

Onboard HDMI connector allows full video & audio support. It has industry-leading high definition video quality.



USB 3.1 Gen 1 Type-A

Experience Fastest data transfers at 5 Gbps with USB 3.1 Gen 1--the new latest connectivity standard. Built to connect easily with next-generation components and peripherals, USB 3.1 Gen 1 transfers data 10X faster and backward compatible with previous USB 2.0 components.



Dual DDR4

The primary advantages of DDR4 over DDR3, include higher module density, lower voltage requirements, coupled with higher data transfer rate.



Moistureproof of PCB

The popularity of PC usage and working environment is getting deteriorating and moist (rural, coastal, etc.). The PCB will be oxidizing easily by damp or absorbed moisture, and ionic migration or CAF (Conductive Anodic Filament) will be generated. Moisture-proof PCB meets high density and high reliability requirements for moisture proof.



Low RdsOn P-Pak MOS

Low resistance design can significantly reduce the current out of energy loss. Low temperature, small size, excellent thermal conductivity.



ESD Protection

ESD (Electrostatic Discharge) is the major factor to destroy the PC by electrical overstress (EOS) condition. ESD occurred by PC users when touch any devices connect to a PC, which may result in damage to the motherboard or parts. ESD protection is designed to protect the motherboard and equipment from damage by EOS.



USB Polyswitch

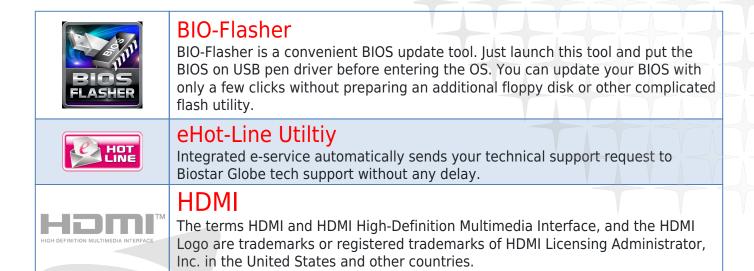
On board dedicated power fuse to help prevent USB port failure. It prevents USB Port overcurrent and safe guard your system and device lifespan.





OC / OV / OH Protection

OC / OV / OH Protection design detects overvoltage conditions and prevents voltage surges from spreading in real time. It also actively cuts off the overvoltage supply to protect your system.



*The specification and pictures are subject to change without notice and the package contents may differ by area or your motherboard version!

